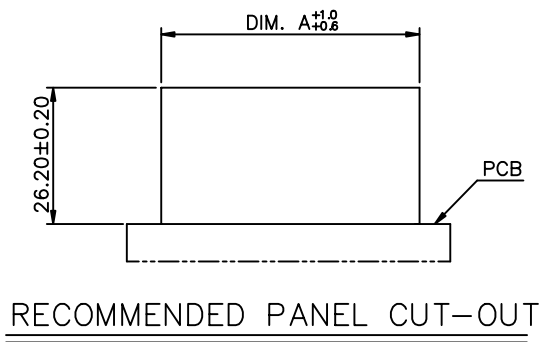
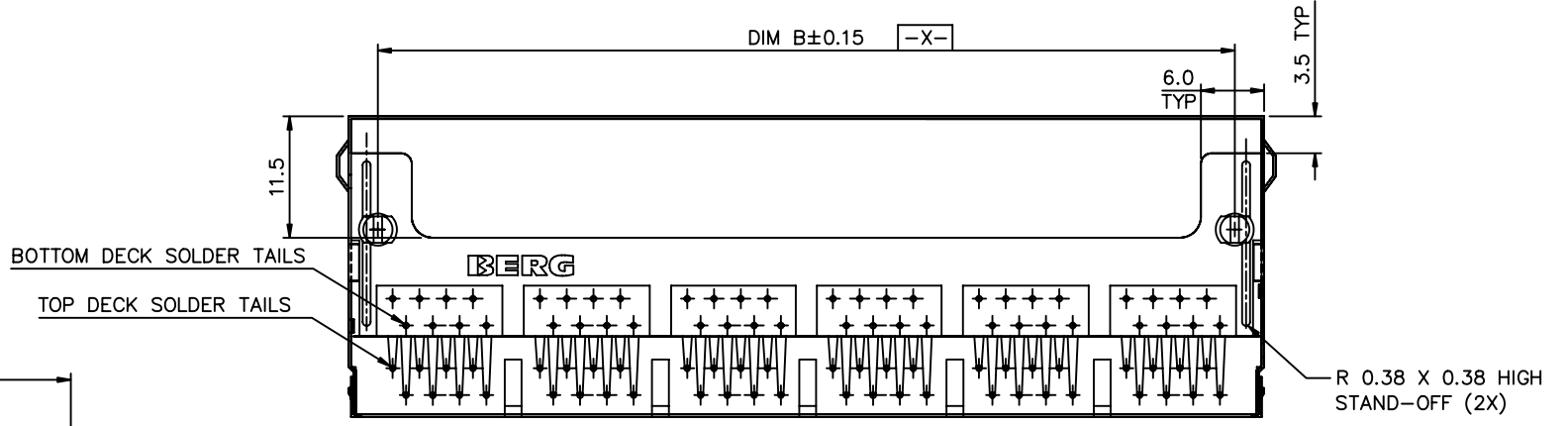
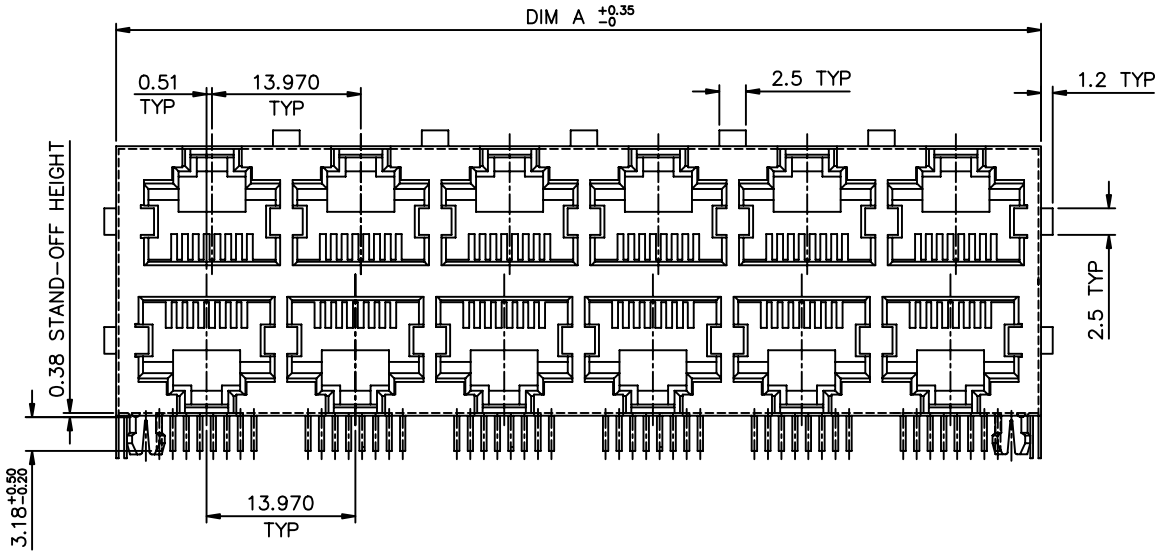
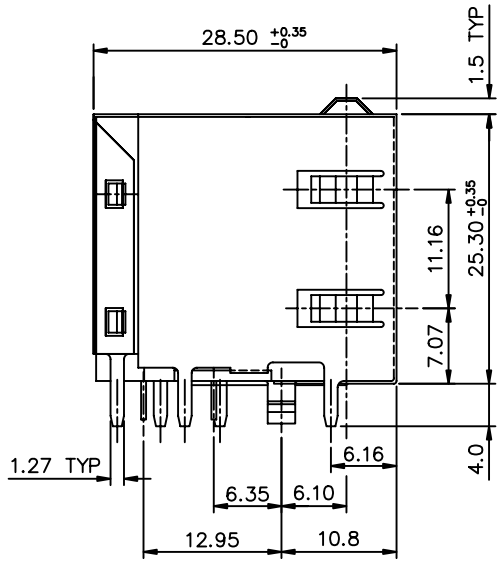


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mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	FCI www.fciconnect.com	
rev.	ecn no.	dr	date	linear	projection	title
C	T90131	M	04/15/99	.0 ± 0.25		RJ45 DOUBLE DECK GANG JACK ASSY
D	T00173	C	05/09/00	.00 ± 0.13		
E	T00239	C	08/02/00	.000 ± 0.05		
F	T03-0443	W	10/08/03	angles ± 2°		
G	N05-0018	YS	01/25/05	dr CATHY LIN 05/26/98	unit	product family MOD JACK code
H	N08-0100	SH	09/25/08	enr TONY CHIEN 05/26/98	mm/inch	size
				chr TONY CHIEN 05/26/98	scale	dwg no.
				appd JENN TSAO 05/26/98	2:1	74633
sheet	revisor	G	G			
index	sheet	1	2			

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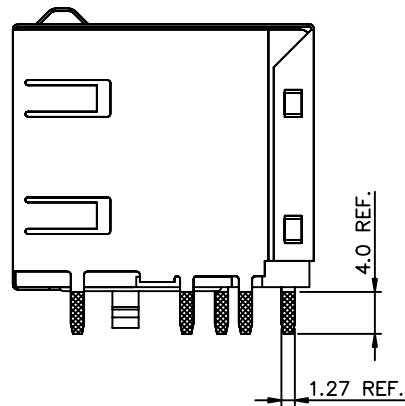
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PRODUCT NO.	PORT NUMBERS	DIM. A ^{+0.35} ₋₀	DIM. B±0.15	PACKAGING	REMARKS	PLATING
74633-004-R 74633-004-RLF	4x2	58.92	53.34	USING TRAY	AVAILABLE	30 v" G.X.T.
74633-304-R 74633-304-RLF						30 v" GOLD. ⑧
74633-504-R 74633-504-RLF						50 v" GOLD.

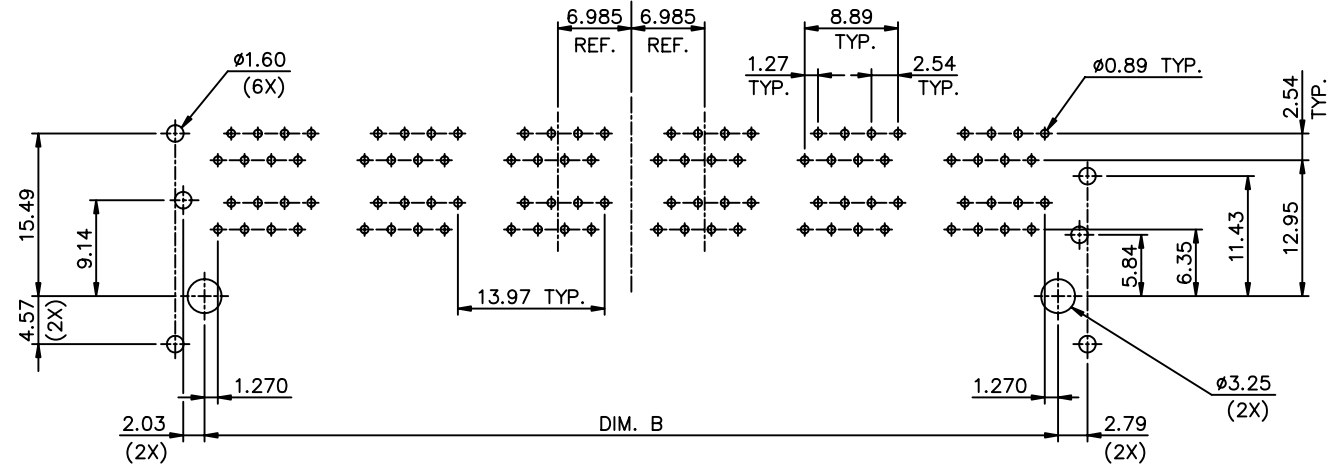
LEAD FREE PRODUCT NO.

NOTES:

- RECOMMENDED P.C.B THICKNESS 1.60 MM
- HOUSING MAT'L: NYLON 6/6, 25% G.F., UL 94V-0, COLOR - BLACK.
- CONTACTS: PHOS BRONZE ALLOY UNS-C51000, Ø 0.460 ROUND WIRE, PLATING SEE TABLE.
- SHIELDING MATERIAL: 0.25MM THICK, BRASS ALLOY. SHIELDING PLATING: 30 v" NICKEL PRE-PLATED AND WITH POST SOLDER DIP ON GROUNDING LEGS AS DETAIL C (IF LF P/N WITH POST PURE TIN SOLDER DIP).
- IF LF P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.60mm MINIMUM THICK CIRCUIT BOARD.
- IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION.
- EQUIVALENT THICKNESS Au AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR.



DETAIL C
NOTE 4



RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE

mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		FCJ www.fciconnect.com	
rev.	ecn no.	dr	date	linear	.0 ± 0.25	projection	title RJ45 DOUBLE DECK GANG JACK ASSY
H					.00 ± 0.13		
				angles	.000± 0.05		
				dr	CATHY LIN D5/26/98	unit	product family
				enr	TONY CHIEN D5/26/98	mm/inch	MOD JACK
				chr	TONY CHIEN D5/26/98	scale	code
				appd	JENN TSAO D5/26/98	2:1	TWN
sheet		revision		size		dwg no.	
index		sheet		A3		74633	
						sheet	
						2 OF	